

LAW OFFICES OF

**JACOBSON HOLMAN**

PROFESSIONAL LIMITED LIABILITY COMPANY

400 SEVENTH STREET, N. W.

WASHINGTON, D. C. 20004

(202) 638-6666

YOON S. HAM

Direct: (202) 662-8483

yham@jphs.com

December 18, 2001

JACOBSON HOLMAN STERN

OF COUNSEL  
MARVIN R. STERN  
NATHANIEL A. HUMPHRIES

TELEFAX  
(202) 393-5350  
(202) 393-5351  
(202) 393-5352

E-MAIL IP@JHIP.COM  
INTERNET WWW.JHIP.COM

\*BAR OTHER THAN DC

HARVEY B. JACOBSON, JR.  
JOHN CLARKE HOLMAN  
SIMOR L. MOSKOWITZ  
ALLEN S. MELSER  
MICHAEL R. SLOBASKY  
MARSHA G. GENTNER  
JONATHAN L. SCHERER  
IRWIN M. AISENBERG  
GEORGE W. LEWIS  
WILLIAM E. PLAYER  
YOON S. HAM  
PHILIP L. O'NEILL  
LINDA J. SHAPIRO  
LEESA N. WEISS  
SUZIN C. BAILEY\*  
MATTHEW J. CUCCIAS  
DANIEL K. DORSEY  
SUZANNAH K. SUNDBY\*



Atty.Docket No.: 10729-P67426USO

CUSTOMER NUMBER: 00136

Honorable Commissioner for Patents  
Washington, D.C. 20231

Sir:

Transmitted herewith for filing is the patent application in the name of:

**Joon Ki HONG of Kyoungki-do, Republic of Korea,**

for **STACK CHIP MODULE**. The application comprises a 18-page specification including 9 claims (1 independents) and Abstract, 5 sheets of drawings (Figs. 1-9), and a Declaration and Power of Attorney.

Also accompanying this application for filing are:

- (1) Assignment document, cover sheet and **\$40.00** fee for recordation of Assignment;
- (2) Information Disclosure Statement; PTO-1449 form and copies of references; and
- (3) A certified copy of **Korean** Application No. **2001-52870**, filed **August 30, 2001**, the priority of which is claimed under 35 U.S.C. §119.

The filing fee has been calculated as shown:

Large Entity	\$ 740.00
Total Claims= <u>09</u> ; in excess of 20 = 0 x (\$18.00) =	0.00
Total Ind. Claims= <u>01</u> ; in excess of 03 = 0 x (\$84.00) = +	0.00
TOTAL FILING FEE:	<b>\$ 740.00</b>

A check in the amount of **\$780.00**, is enclosed to cover the Filing Fee and an Assignment Recordation Fee. The Commissioner is hereby authorized to charge payment of any fees set forth in Sections 1.16 or 1.17 during the pendency of this application, or credit any overpayment, to deposit Account No. 06-1358. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

By: 

Yoon S. Ham

Reg. No. 45,307

Enclosures  
YSH:ecl

